

### **Features**

- 0.8T Side view PLCC SMD LED
- High reliability
- General purpose leads
- Peak wavelength λp=940nm
- Mechanically and spectrally matched to the phototransistor
- Low forward voltage
- High radiant intensity

# **Applications**

- Optoelectronic Switch
- IR Touch-Panel
- Industrial IR Equipment
- Consumer Electronics
- High Speed IR Communications

### **Description**

The IN-P281ASGHIR is a popular 0.8T side view package with versatile design capabilities. It is a PLCC type LED which can be used in various applications.

### **Recommended Solder Pattern**

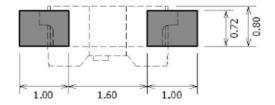
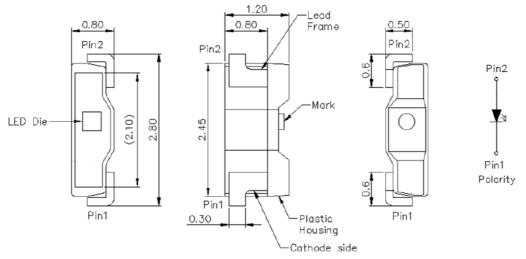


Figure 1. IN-P281ASGHIR Solder Pattern

# Package Dimensions in mm



#### Notes.

- 1. All dimensions are in millimeters.
- 2. Tolerance is ± 0.10 mm unless otherwise noted

Figure 2. IN-P281ASGHIR Package Dimensions



# Absolute Maximum Rating at 25°C (Note 1)

| Product       | Emission<br>Color | P <sub>d</sub> (mW) | I <sub>F</sub> (mA) | I <sub>FP</sub> * (mA) | V <sub>R</sub> (V) | Top (°C)    | T <sub>ST</sub> (°C) |
|---------------|-------------------|---------------------|---------------------|------------------------|--------------------|-------------|----------------------|
| IN-P281ASGHIR | Infrared          | 210                 | 100                 | 1000                   | 5                  | -40°C~+85°C | -40°C~+100°C         |

#### **Notes**

1. Ifp Conditions--Pulse Width  $\leq\!100\mu s$  and Duty  $\leq\!1\%.$ 

#### **ESD Precaution**

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).

### **Electrical Characteristics** $T_A = 25\%$ (Note 1)

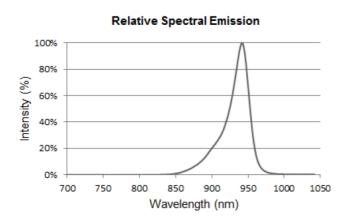
|               |                   |         | V <sub>F</sub> (V) |     | λ(nm)      |                |    | Viewing<br>Angle | le (mW/sr) |
|---------------|-------------------|---------|--------------------|-----|------------|----------------|----|------------------|------------|
| Product       | Emission<br>Color | II-(mΔ) | min                | max | <b>λ</b> D | λ <sub>P</sub> | Δλ | 2θ1/2            | typ.       |
| IN-P281ASGHIR | Infrared          | 100     | 1.3                | 2.1 | 1          | 940            | 30 | 120              | 12.5       |

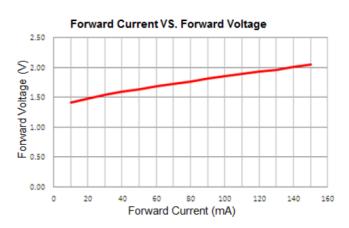
#### **Notes**

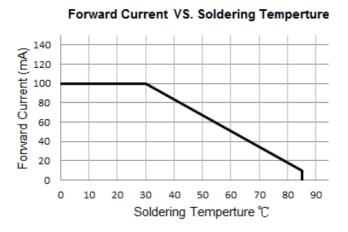
1. Performance guaranteed only under conditions listed in above tables.

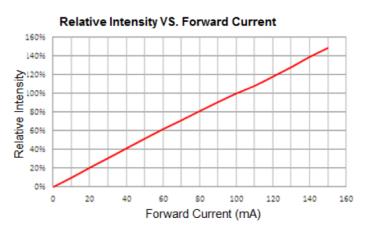


# **Typical Characteristic Curves**

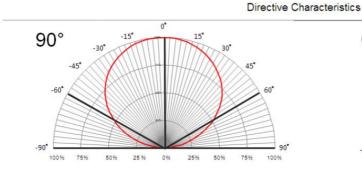


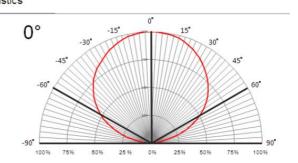






# **Typical Characteristic Curves - Radiation Pattern**



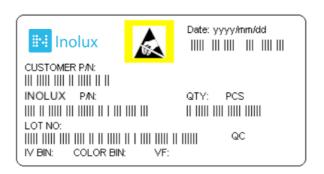




# **Ordering Information**

| Product       | Emission Color | Technology | Test<br>Current<br>I <sub>F</sub> (mA) | Radiant Intensity<br>le (mW/sr)<br>(Typ.) | Forward<br>Voltage<br>V <sub>F</sub> (V)<br>(Typ.) | Orderable<br>Part Number |
|---------------|----------------|------------|--|---|--|--------------------------|
| IN-P281ASGHIR | Infrared       | AlGaAs     | 100                                    | 12.5                                      | 1.5  | IN-P281ASGHIR            |

# **Label Specifications**



### **Inolux P/N:**

| I  | N    | - | Р                | 281                            | А         | S                 | G         |                    | HIR         | - | Х | Х | Х              | Х |
|----|------|---|------------------|--------------------------------|-----------|-------------------|-----------|--------------------|-------------|---|---|---|----------------|---|
|    |      |   | Material         | Package                        | Variation | Orientation       | Current   | Lens               | Color       |   |   |   | mizec<br>p-off |   |
| In | olux |   | P = PLCC<br>Type | 281A = 0.8T, 2.8mm x<br>1.2 mm |           | S = Side<br>Mount | G = 100mA | (Blank) =<br>clear | HIR = 940nm |   |   |   |                |   |

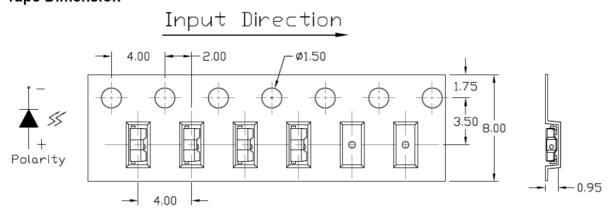
# Lot No.:

| Z        | 2 | 0          | 1        | 7        | 01   | 24     | 001 |
|----------|---|------------|----------|----------|------|--------|-----|
| Internal |   | Voor (2017 | 2019 \   | Month    | Data | Serial |     |
| Tracker  |   | Year (2017 | , 2016,) | WIOTILIT | Date | Seriai |     |



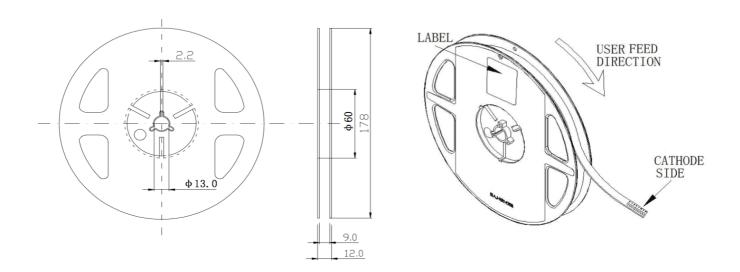
# Packaging Information: 2000pcs Per Reel

# Packaging Tape Dimension



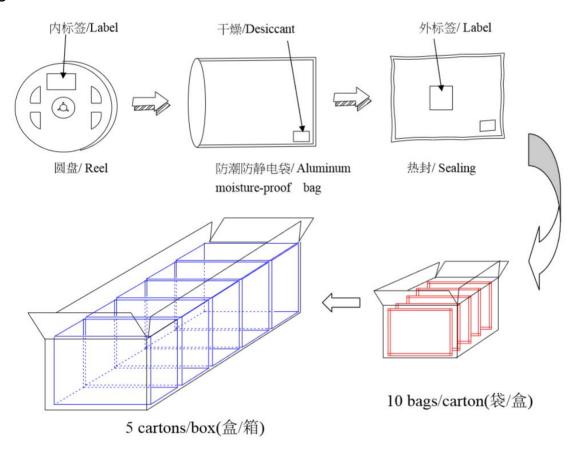
| Dim. A    | Dim. B    | Dim. C    | Q'ty/Reel |
|-----------|-----------|-----------|-----------|
| 3.05±0.10 | 1.35±0.10 | 0.95±0.10 | 2K        |

### **Reel Dimension**





# **Packing Dimension**



5 boxes per carton are available depending on shipment quantity.

| Specification        | Material  | Quantity   |
|----------------------|---|--|
| Per EIA 481-1A specs | Conductive black tape   | 2000pcs per reel   |
| Per EIA 481-1A specs | Conductive black  |  |
| IN standard          | Paper   |  |
| 220x240mm            | Aluminum laminated bag/ no-zipper                               | One reel per bag   |
| IN standard          | Paper   | Non-specified  |
|                      | Per EIA 481-1A specs Per EIA 481-1A specs IN standard 220x240mm | Per EIA 481-1A specs Conductive black tape Per EIA 481-1A specs Conductive black IN standard Paper 220x240mm Aluminum laminated bag/ no-zipper |

#### Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv,  $\lambda_P$  and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

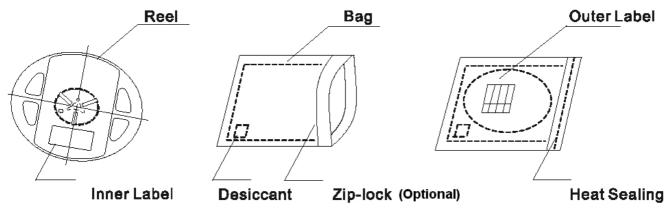


# **Dry Pack**

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

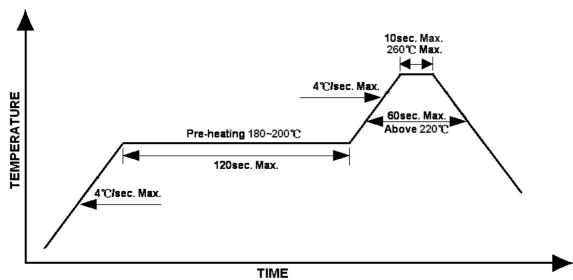
The packaging sequence is as follows:



# **Reflow Soldering**

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):







### **Precautions**

- Avoid exposure to moisture at all times during transportation or storage.
- Anti-Static precaution must be taken when handling GaN, InGaN, and AllnGaP products.
- It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage.
- Avoid operation beyond the limits as specified by the absolute maximum ratings.
- Avoid direct contact with the surface through which the LED emits light.
- If possible, assemble the unit in a clean room or dust-free environment.

### Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

### **Cleaning**

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min</li>

### **Cautions of Pick and Place**

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.





Reliability

| Item                | Frequency/ lots/ samples/  | Standards       | Conditions                                 |  |  |  |
|---------------------|----------------------------|-----------------|--|--|--|--|
| Item                | failures                   | Reference       |  |  |  |  |
|                     | For all reliability        | J-STD-020       | 1.) Baking at 85°C for 24hrs               |  |  |  |
| Precondition        | monitoring tests according |                 | 2.) Moisture storage at 85°C/60% R.H. for  |  |  |  |
|                     | to JEDEC Level 2           |                 | 168hrs                                     |  |  |  |
|                     | 1Q/ 1/ 22/ 0               | JESD22-B102-B   | Accelerated aging 155°C/ 24hrs             |  |  |  |
| Solderability       |                            | And CNS-5068    | Tinning speed: 2.5+0.5cm/s                 |  |  |  |
|                     |                            |                 | Tinning: A: 215°C/ 3+1s or B: 260°C/ 10+1s |  |  |  |
|                     |                            | CNS-5067        | Dipping soldering terminal only            |  |  |  |
| Resistance to       |                            |                 | Soldering bath temperature                 |  |  |  |
| soldering heat      |                            |                 | A: 260+/-5°C; 10+/-1s                      |  |  |  |
|                     |                            |                 | B: 350+/-10°C; 3+/-0.5s                    |  |  |  |
|                     | 1Q/ 1/ 40/ 0               | CNS-11829       | 1.) Precondition: 85°C baking for 24hrs    |  |  |  |
| Operating life test |                            |                 | 85°C/ 60%R.H. for 168hrs                   |  |  |  |
|                     |                            |                 | 2.) Tamb25°C; IF=20mA; duration 1000hrs    |  |  |  |
| High humidity,      | 1Q/ 1/ 45/ 0               | JESD-A101-B     | Tamb: 85°C                                 |  |  |  |
| high temperature    |                            |                 | Humidity: 85% R.H., IF=5mA                 |  |  |  |
| bias                |                            |                 | Duration: 1000hrs                          |  |  |  |
| High temperature    | 1Q/ 1/ 20                  | IN specs.       | Tamb: 55°C                                 |  |  |  |
| bias                |                            |                 | IF=20mA                                    |  |  |  |
| Dias                |                            |                 | Duration: 1000hrs                          |  |  |  |
|                     | 1Q/ 1/ 40/ 0               |                 | Tamb25°C, If=20mA,, Ip=100mA, Duty         |  |  |  |
| Pulse life test     |                            |                 | cycle=0.125 (tp=125 $\mu$ s,T=1sec)        |  |  |  |
|                     |                            |                 | Duration 500hrs)                           |  |  |  |
|                     | 1Q/ 1/ 76/ 0               | JESD-A104-A     | A cycle: -40 degree C 15min; +85 degree C  |  |  |  |
| Tomporoturo         |                            | IEC 68-2-14, Nb | 15min                                      |  |  |  |
| Temperature cycle   |                            |                 | Thermal steady within 5 min                |  |  |  |
| Cycle               |                            |                 | 300 cycles                                 |  |  |  |
|                     |                            |                 | 2 chamber/ Air-to-air type                 |  |  |  |
| High humidity       | 1Q/ 1/ 40/ 0               | CNS-6117        | 60+3°C                                     |  |  |  |
| storage test        |                            |                 | 90+5/-10% R.H. for 500hrs                  |  |  |  |
| High temperature    | 1Q/ 1/ 40/ 0               | CNS-554         | 100+10°C for 500hrs                        |  |  |  |
| storage test        |                            |                 |  |  |  |  |
| Low temperature     | 1Q/ 1/ 40/ 0               | CNS-6118        | -40+5°C for 500hrs                         |  |  |  |
| storage test        |                            |                 |  |  |  |  |





# **Revision History**

| Changes since last revision | Page | Version No. | Revision Date |
|-----------------------------|------|-------------|---------------|
| Initial Release             |      | 1.0         | 01-29-2019    |
|                             |      |             |               |
|                             |      |             |               |
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